

ME60N10T-VB Datasheet N-Channel 100-V (D-S) MOSFET

PRODUCT	SUMMARY	
V _{(BR)DSS} (V)	r _{DS(on)} (Ω)	I _D (A)
100	0.017 at V _{GS} = 10 V	70 ^a

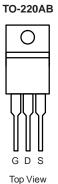
FEATURES

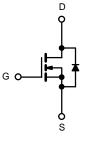
- TrenchFET[®] Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- 100 % R_g Tested

APPLICATIONS

• Isolated DC/DC Converters







N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	$T_{C} = 25 \text{ °C}, \text{ unless oth}$	erwise noted		
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V _{DS}	100	V
Gate-Source Voltage		V _{GS}	± 20	V
Continuous Drain Current ($T_1 = 175 ^{\circ}C$)	T _C = 25 °C	I _D	70 ^a	
Continuous Drain Current (1) = 175 C)	T _C = 125 °C	D	35 ^a	A
Pulsed Drain Current		I _{DM}	145	
Avalanche Current	L = 0.1 mH	I _{AS}	31	
Single Pulse Avalanche Energy ^b	L = 0.11111	E _{AS}	60	mJ
	T _C = 25 °C	Р	355 ^c	w
Maximum Power Dissipation ^b	T _A = 25 °C ^d	- P _D -	3.35	vv
Operating Junction and Storage Temperature Ra	ange	T _J , T _{stg}	- 55 to 175	°C

THERMAL RESISTANCE F	ATINGS			
Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount	R _{thJA}	40	°C/W
Junction-to-Case (Drain)		R _{thJC}	0.4	0/11

Notes:

a. Package limited.

b. Duty cycle \leq 1 %.

c. See SOA curve for voltage derating.

d. When Mounted on 1" square PCB (FR-4 material).

SPECIFICATIONS $T_J = 25^{\circ}$ Parameter	Symbol	Test Conditions	Min.	Turn	Max.	Unit	
Static	Symbol	lest conditions	wiin.	Тур.	wax.	Unit	
Drain-Source Breakdown Voltage	V	V _{DS} = 0 V, I _D = 250 μA	100			1	
•	V _{(BR)DSS}	$V_{DS} = 0.0, I_D = 250 \mu A$ $V_{DS} = V_{GS}, I_D = 250 \mu A$			4	V	
Gate-Threshold Voltage	V _{GS(th)}		2				
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$			50	μΑ	
		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 \text{ °C}$			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 V, V_{GS} = 10 V$	120			A	
		V _{GS} = 10 V, I _D = 30 A		0.017			
Drain-Source On-State Resistance ^a	r _{DS(on)}	V_{GS} = 10 V, I _D = 30 A, T _J = 125 °C		0.023		A Ω S pF nC	
		V_{GS} = 10 V, I_{D} = 30 A, T_{J} = 175 °C		0.037			
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 30 \text{ A}$	25			S	
Dynamic ^b							
Input Capacitance	C _{iss}			1800		nA μA Α Ω S PF nC Ω ns	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$, $V_{DS} = 25 V$, f = 1 MHz		210			pF
Reverse Transfer Capacitance	C _{rss}			110			
Total Gate Charge ^c	Qg			90			
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 100 V, V_{GS} = 10 V, I_{D} = 58 A		23		nC	
Gate-Drain Charge ^c	Q _{gd}			34			
Gate Resistance	R _g		0.5	1.3	3.1	Ω	
Turn-On Delay Time ^c	t _{d(on)}			24	35		
Rise Time ^c	t _r	V_{DD} = 100 V, R _L = 1.5 Ω		220	330		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 58$ A, V_{GEN} = 10 V, R_g = 2.5		45	70	- ns	
Fall Time ^c	t _f	Ω		200	300		
Source-Drain Diode Ratings and Cha	aracteristics 7	_C = 25 °C ^b		<u>. </u>			
Continuous Current	I _S				70	_	
Pulsed Current	I _{SM}			115		A	
Forward Voltage ^a	V _{SD}	I _F = 58 A, V _{GS} = 0 V		1.0	1.5	V	
Reverse Recovery Time	t _{rr}			130	200	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 30 A, di/dt = 100 A/μs		8	12	A	
Reverse Recovery Charge	Q _{rr}			0.52	1.2	μC	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

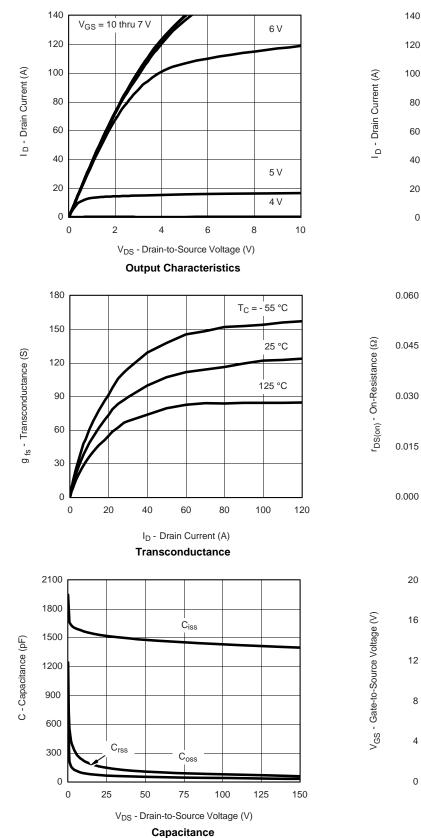
b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

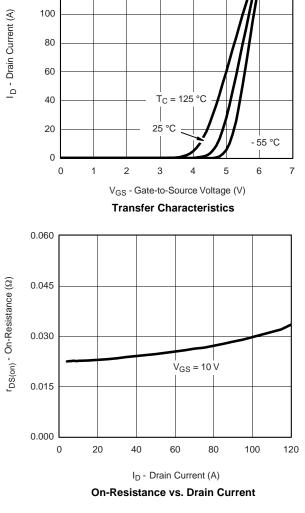
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

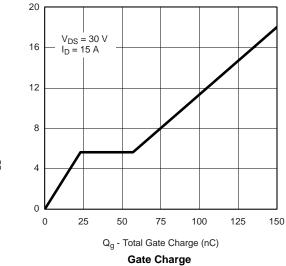
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

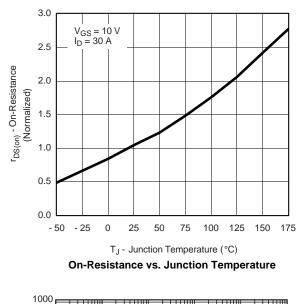


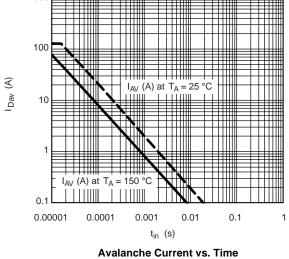


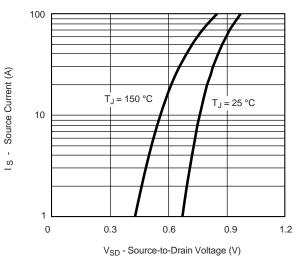
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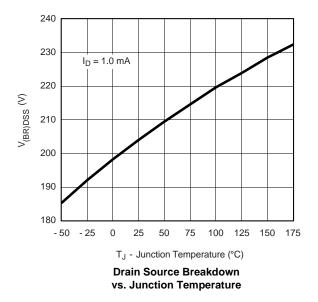
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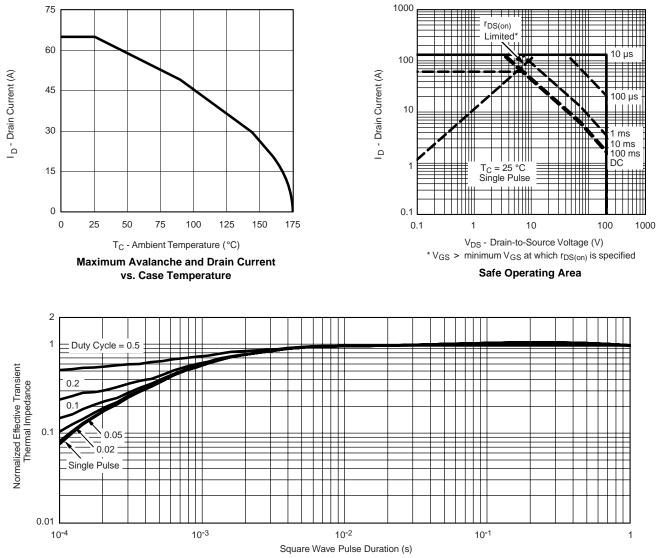


Source-Drain Diode Forward Voltage





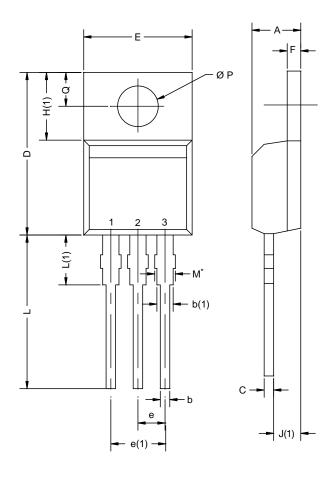
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



TO-220AB



DIM.	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	

Notes

* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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